

WHAT IS CLAIMED IS:

1. A flexible printed circuit board comprising:
  - a substrate layer;
  - at least a circuit layer formed on said substrate layer; and
  - a conductive film layer formed on one end of said circuit layer, characterized in that a pitch of said conductive film layer is broadened to be ranged from 0.5 mm to 3.0 mm.
2. The flexible printed circuit board according to claim 1, wherein the other end of said circuit layer is formed to be a golden-finger region and is electrically connected to the LCD circuit board.
3. The flexible printed circuit board according to claim 1, wherein said conductive film comprises conductive particles and sticky polymers.
4. The flexible printed circuit board according to claim 3, wherein said conductive particles are one of metal-plated polymer particles and nickel particles.
5. The flexible printed circuit board according to claim 4, wherein said metal of said metal-plated polymer particles is selected from a group consisting of a nickel, a copper, a gold, and a silver.
6. The flexible printed circuit board according to claim 1, wherein said substrate layer is a plastic layer.
7. The flexible printed circuit board according to claim 6, wherein said plastic layer comprises a polyimide layer and a polypropylene / epoxy resin layer.
8. The flexible printed circuit board according to claim 1, wherein said plastic layer comprises a polyimide layer.
9. The flexible printed circuit board according to claim 1, wherein said circuit layer is a copper circuit layer.

10. The flexible printed circuit board according to claim 1 further comprising an integrated circuit disposed thereon which is packaged by using one of a tape carrier package and a chip on film.
11. The flexible printed circuit board according to claim 1 further comprising surface mounting devices (SMD).
12. The flexible printed circuit board according to claim 1, wherein said conductive film is an anisotropic conductive film.
13. The flexible printed circuit board according to claim 1, wherein said flexible circuit board is connected to a liquid crystal display via said conductive film layer.
14. A flexible printed circuit board comprising:
  - at least two substrate layer;
  - at least a circuit layer formed between every adjacent two said substrate layer; and
  - at least a conductive film layer formed on one end of said circuit layer, characterized in that a pitch of said conductive film layer is broadened to be ranged from 0.5 mm to 3.0 mm.
15. The flexible printed circuit board according to claim 14, wherein the other end of said circuit layer is formed to be a golden-finger region and is electrically connected to the LCD circuit board.
16. The flexible printed circuit board according to claim 14, wherein said conductive film comprises conductive particles and sticky polymers.
17. The flexible printed circuit board according to claim 16, wherein said conductive particles are one of metal-plated polymer particles and nickel particles.

18. The flexible printed circuit board according to claim 17, wherein said metal of said metal-plated polymer particles is selected from a group consisting of a nickel, a copper, a gold, and a silver.
19. The flexible printed circuit board according to claim 14, wherein said substrate layer is a plastic layer.
20. The flexible printed circuit board according to claim 14 further comprising surface mounting devices (SMD).